



[10191/2251]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : SPITZ et al. Confirmation No.: 7205
Serial No. : 10/070,521
Filed : July 8, 2002
For : ARRANGEMENT HAVING P-DOPED AND N-DOPED SEMICONDUCTOR LAYERS, AND METHOD FOR THE MANUFACTURE THEREOF

Examiner : J. Jackson, Jr.

Art Unit : 2815

Customer No. : 26646

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:
Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450
ca

Date 7/10/06 Atty's Reg. # 41,172

Atty's Signature LG2
DERVIS MAGISTRE
KENYON & KENYON LLP

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT TRANSMITTAL

SIR:

Please find an Amendment transmitted herewith for filing in the above-identified patent application.

No fee is believed to be required. However, if any fee is required, please use Deposit Account No. 11-0600. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,

KENYON & KENYON LLP

Dated: 7/10/06

By: LG2 (Reg. No. 41,172)
802

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DERVIS MAGISTRE
KENYON & KENYON LLP

AMENDMENT

SIR:

In response to the Office Action dated April 10, 2006, please amend the
above-identified application as set forth below.

Amendments to the Specification do not appear in this paper.

Amendments to the Claims are reflected in the listing of the claims which begins on page 2
of this paper.

Amendments to the Drawings do not appear in this paper.

Remarks begin on page 5 of this paper.